

Description

The AON6407 uses advanced trench technology

to provide excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = -30V I_D =-100A

 $R_{DS(ON)} < 4 \text{ m}\Omega \text{ V}_{GS}$ =-10V

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

SSS G DD DD
Pin 1

DFN5X6-8L (PDFN-8(5.8x4.9))



P-Channel MOSFET

Product ID	Pack	Brand	Qty(PCS)
AON6407	DFN5X6-8L(PDFN-8(5.8x4x.9))	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units	
Vds	Drain-Source Voltage	-30	V	
Vgs	Gate-Source Voltage	±20	V	
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	-100	А	
l⊳@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	-70	А	
Ідм	Pulsed Drain Current ²	-250	А	
EAS	Single Pulse Avalanche Energy ³	80	mJ	
las	Avalanche Current	-70	А	
P₀@Tc=25°C	Total Power Dissipation ⁴	120	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Reja	Thermal Resistance Junction-Ambient ¹	50	°C/W	
Rejc	Thermal Resistance Junction-Case ¹	1.6	°C/W	



Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BV_{DSS}	Drain-Source Breakdown Voltage	rce Breakdown Voltage V _{GS} =0V , I _D =-250uA				V	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-20A		3	4.0	mΩ	
	Static Drain-Source On-Resistance	V _{GS} =-4.5V , I _D =-15A		4.2	6.0	mΩ	
V _{GS(th)}	Gate Threshold Voltage	Gate Threshold Voltage $V_{GS}=V_{DS}$, $I_D=-250uA$			-2.5	V	
		V _{DS} =-24V , V _{GS} =0V , T _J =25℃			-1		
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , TJ=55℃			-5	uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.2		Ω	
Qg	Total Gate Charge (-10V)			60			
Q_gs	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-10V , I _D =-18A		9		nC	
Q_{gd}	Gate-Drain Charge			15			
T _{d(on)}	Turn-On Delay Time			17			
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω ,		40			
T _{d(off)}	Turn-Off Delay Time	I _D =-20A		55		ns	
T _f	Fall Time			13			
C _{iss}	Input Capacitance			3450			
C _{oss}	Output Capacitance	V _{DS} =-25V , V _{GS} =0V , f=1MHz		255		pF	
C _{rss}	Reverse Transfer Capacitance			140			
ls	Continuous Source Current ^{1,5}	$V_G = V_D = 0V$, Force Current			-100	А	
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25°C			-1.2	V	
t _{rr}	Reverse Recovery Time	IF=-20A , di/dt=100A/µs ,		22		nS	
Q _{rr}	Reverse Recovery Charge			72		nC	

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$

3.The EAS data shows Max. rating . The test condition is V_{DD}=-50V,V_{GS}=-10V,L=0.1mH,I_{AS}=-40A 4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation

6.The maximum current rating is package limited.



Typical Characteristics

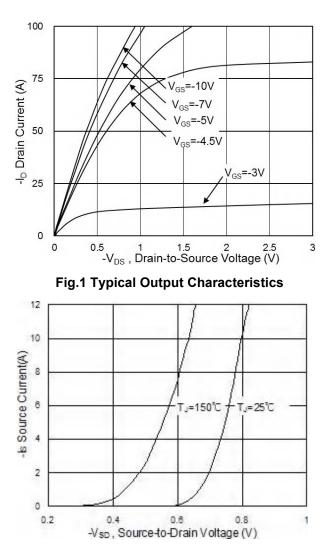
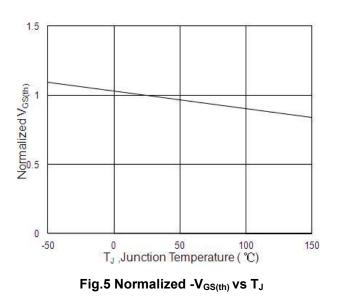
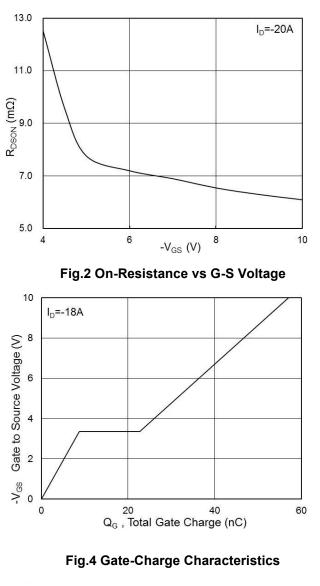
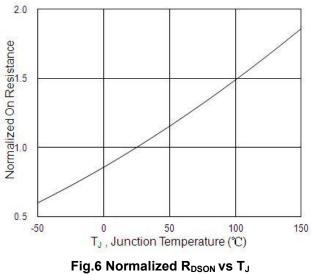
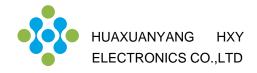


Fig.3 Source Drain Forward Characteristics









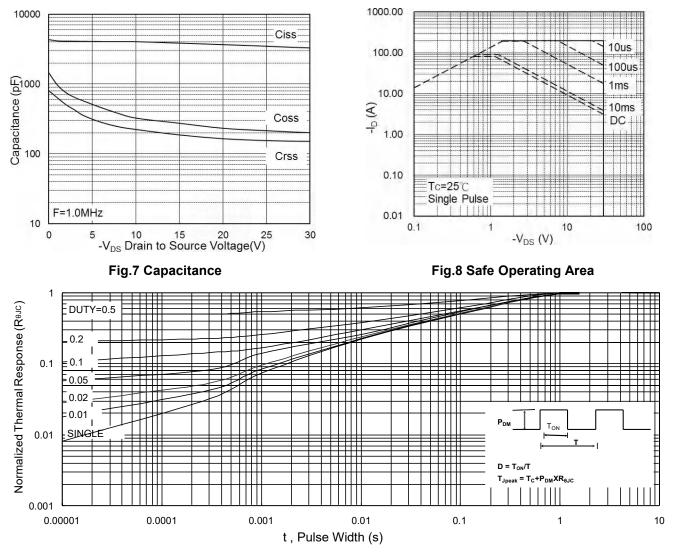


Fig.9 Normalized Maximum Transient Thermal Impedance

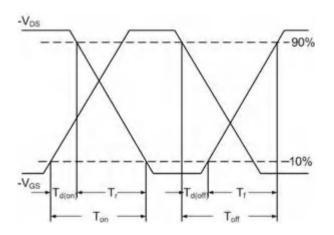


Fig.10 Switching Time Waveform

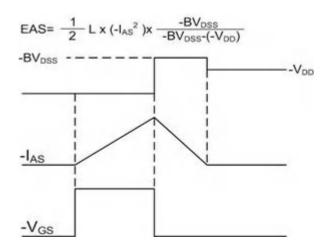
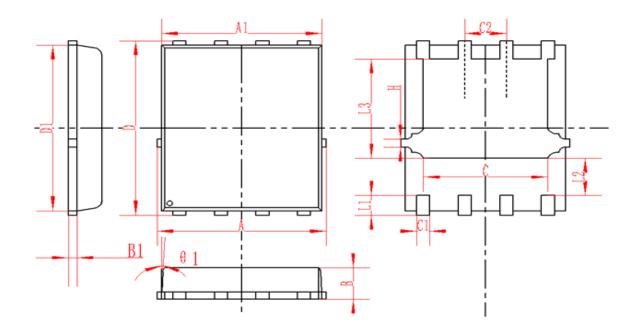


Fig.11 Unclamped Inductive Switching Waveform



DFN5X6-8L(PDFN-8(5.8x4.9)) Package Information



SYMBOL		MM			INCH		
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.95	5	5.05	0.195	0.197	0.199	
A1	4.82	4.9	4.98	0.190	0.193	0.196	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.67	5.75	5.83	0.223	0.226	0.230	
В	0.9	0.95	1	0.035	0.037	0.039	
B1	0.254REF			0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2	1.27TYP			2 1.27TYP 0.5TYP			
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Н	0.24	0.25	0.26	0.009	0.010	0.010	



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